

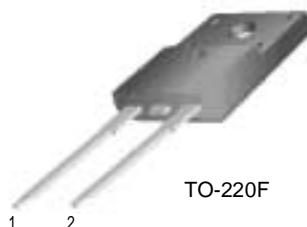
## FFPF15U20S

### Features

- Ultrafast with soft recovery
- Low forward voltage

### Applications

- Power switching circuits
- Output rectifiers
- Freewheeling diodes
- Switching mode power supply



TO-220F



## ULTRA FAST RECOVERY POWER RECTIFIER

### Absolute Maximum Ratings $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Value	Units
$V_{RRM}$	Peak Repetitive Reverse Voltage	200	V
$I_{F(AV)}$	Average Rectified Forward Current @ $T_C = 100^\circ\text{C}$	15	A
$I_{FSM}$	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	150	A
$T_J, T_{STG}$	Operating Junction and Storage Temperature	- 65 to +150	$^\circ\text{C}$

### Thermal Characteristics

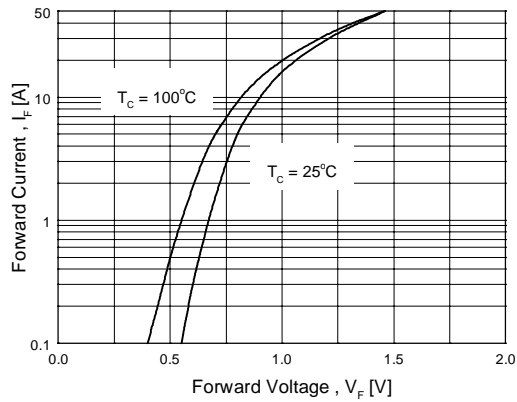
Symbol	Parameter	Value	Units
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case	3.5	$^\circ\text{C/W}$

### Electrical Characteristics $T_C=25^\circ\text{C}$ unless otherwise noted

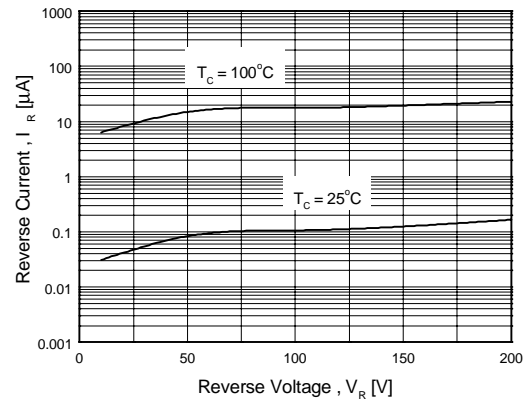
Symbol	Parameter	Min.	Typ.	Max.	Units
$V_{FM}^*$	Maximum Instantaneous Forward Voltage				V
	$I_F = 15\text{A}$	-	-	1.2	
	$T_C = 25^\circ\text{C}$	-	-	1.0	
$I_{RM}^*$	Maximum Instantaneous Reverse Current				$\mu\text{A}$
	@ rated $V_R$	-	-	15	
	$T_C = 25^\circ\text{C}$	-	-	150	
$t_{rr}$	Maximum Reverse Recovery Time	-	-	40	ns
$I_{rr}$	Maximum Reverse Recovery Current	-	-	3.5	A
$Q_{rr}$	Maximum Reverse Recovery Charge ( $I_F = 15\text{A}$ , $di/dt = 200\text{A}/\mu\text{s}$ )	-	-	70	nC
$W_{AVL}$	Avalanche Energy	0.5	-	-	mJ

\* Pulse Test: Pulse Width=300 $\mu\text{s}$ , Duty Cycle=2%

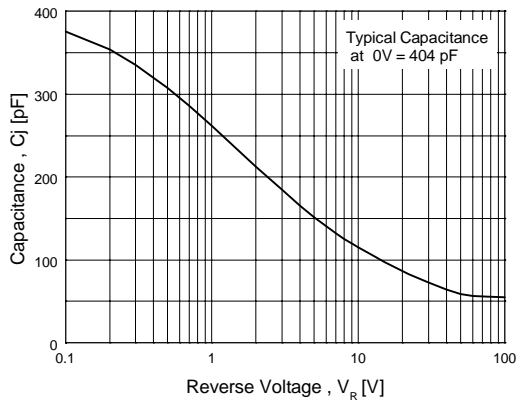
## Typical Characteristics



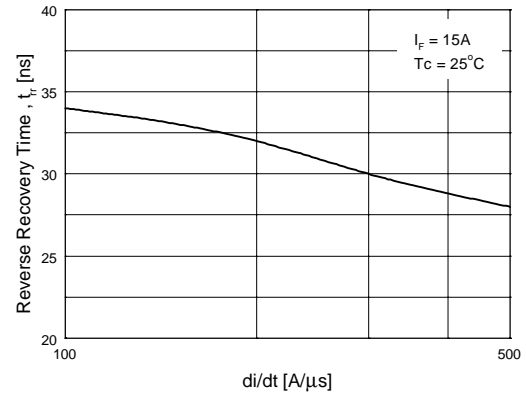
**Figure 1. Typical Forward Voltage Drop vs. Forward Current**



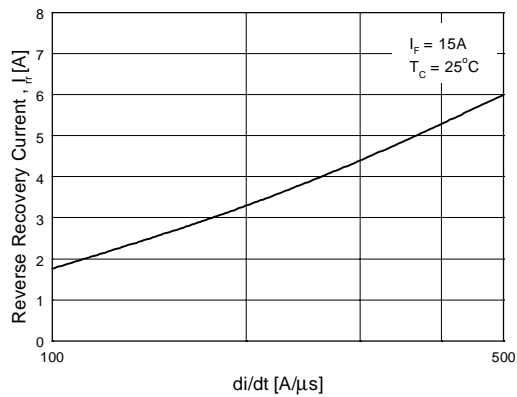
**Figure 2. Typical Reverse Current vs. Reverse Voltage**



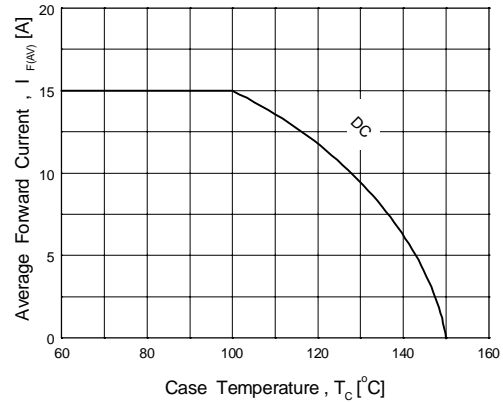
**Figure 3. Typical Junction Capacitance**



**Figure 4. Typical Reverse Recovery Time vs. di/dt**



**Figure 5. Typical Reverse Recovery Current vs. di/dt**



**Figure 6. Forward Current Derating Curve**

**FFPF15U20S**

Technical drawing of a 2.54mm pitch connector, showing three views: front, side, and top.

**Front View Dimensions:**

- Total Height:  $15.80 \pm 0.20$
- Top Section Height:  $3.30 \pm 0.10$
- Bottom Section Height:  $9.75 \pm 0.30$
- Width:  $10.16 \pm 0.20$
- Central Hole Diameter:  $\varnothing 3.18 \pm 0.10$
- Side Hole Diameter:  $\varnothing 1.80$
- Bottom Section Width:  $12.00 \pm 0.20$
- Bottom Section Hole Diameter:  $0.80 \pm 0.10$
- Bottom Section Hole Position:  $0.35 \pm 0.10$
- Bottom Section Hole Depth:  $0.35 \pm 0.10$
- Bottom Section Hole Tolerance:  $2.54 \text{ TYP}$  [ $2.54 \pm 0.20$ ]
- Bottom Section Hole Position:  $0.35 \pm 0.10$
- Bottom Section Hole Depth:  $0.35 \pm 0.10$
- Bottom Section Hole Tolerance:  $2.54 \text{ TYP}$  [ $2.54 \pm 0.20$ ]

**Side View Dimensions:**

- Total Height:  $15.87 \pm 0.20$
- Top Section Height:  $6.68 \pm 0.20$
- Bottom Section Height:  $9.19 \pm 0.20$
- Bottom Section Hole Diameter:  $0.80 \pm 0.10$
- Bottom Section Hole Position:  $0.35 \pm 0.10$
- Bottom Section Hole Depth:  $0.35 \pm 0.10$
- Bottom Section Hole Tolerance:  $2.54 \text{ TYP}$  [ $2.54 \pm 0.20$ ]
- Bottom Section Hole Position:  $0.35 \pm 0.10$
- Bottom Section Hole Depth:  $0.35 \pm 0.10$
- Bottom Section Hole Tolerance:  $2.54 \text{ TYP}$  [ $2.54 \pm 0.20$ ]

**Top View Dimensions:**

- Width:  $9.40 \pm 0.20$
- Depth:  $4.70 \pm 0.20$

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